

PICO-APL3

Supplier: POKI / Gift box size: 150(L)*130(W)*39(H) mm

Package Drop Test Report

Report NO: 17E030001



Summary	<p><input checked="" type="checkbox"/> Pass</p> <p><input type="checkbox"/> Fail Note : There is/are ____ defect(s) not list in the report, please check it in the DTS Website.</p> <p><input type="checkbox"/> Pass with Deviation Comment: _____</p>
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Issue date

2017-12-05

Approval

KJ Wang

Test Engineer

Rex Chang

Test item list

1. *Test item list* ----- 2
2. *Configuration of EUT* ----- 3
3. *Package drop test* ----- 4

Testing Result

Num	Test item list	Result	Remark
1	Package drop test	Pass	

Sample Configuration:

Num	Item	Device Information
1.	Model Name	PICO-APL3 A0.2
2.	BIOS Version	PICO-APL3 R0.4 (ZAP3AM04) (08/21/2017)
3.	CPU	Intel Pentium N4200 / 1.10GHz
4.	Memory	On board 4GB / DDR3L / SEC K4B8G1646D MYKO
5.	eMMC Flash	On board 32GB / Kingston.EMMC32G-M525-A51
6.	Test Software	Windows 10 / Run PassMark Burn In Test 8.1 Pro
7.	AT Power supply	Zippy HG2-6400P 400W



Package Drop Test

Test Date: 12-05-2017

Test Product: PICO-APL3

Test Site: AAEON QE Dept.

Test Standard:

Reference ISTA PROJECT 2A

Test Equipment:

Drop Tester

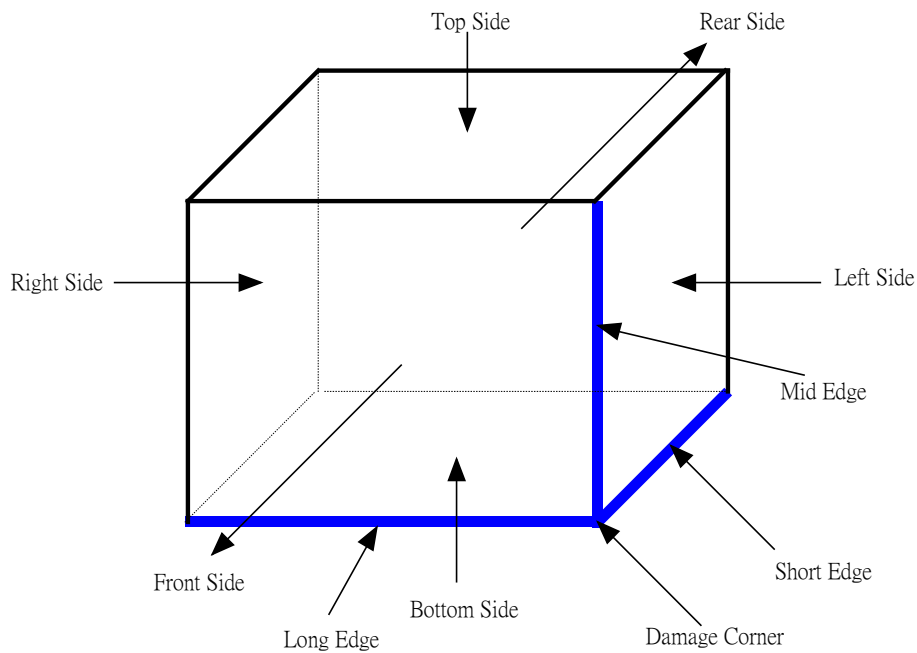
KING DESIGN Co. LTD.

Model: KD-128A

Serial Number: UU110099190

Test Condition:

1. Test Phase: One corner. Three edges. Six face
2. Test Cycle: 1 Cycle
3. Test High: 97cm
4. Test Weight: 0.14Kg
5. Sample Package: 1unit in single-package.
6. Test Drawing:



Test Result:

Packaging is not broken, main board no structure deformation and function was working normally after drop test.